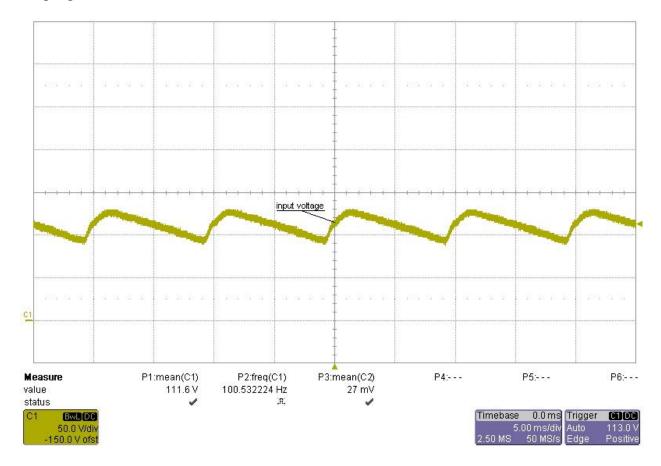


1 Input voltage ripple

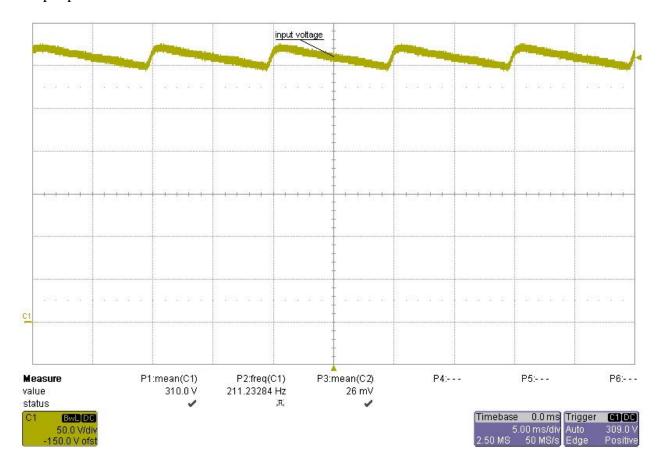
Input voltage = 90VAC Output power = 20W



PMP10020_RevB Test Results



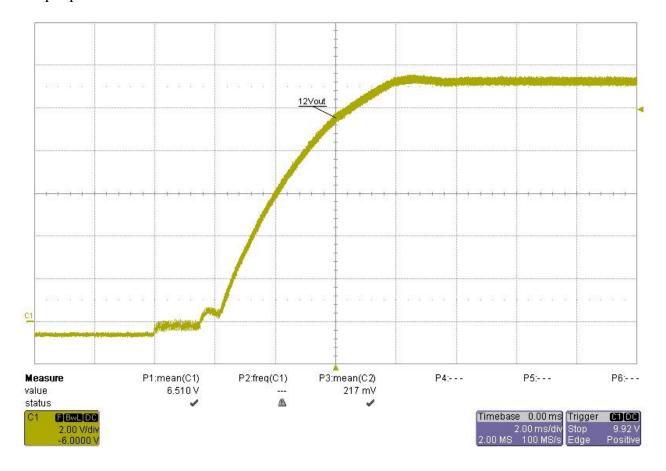
Input voltage = 230VAC Output power = 30W





2 Startup (regulated 12V output)

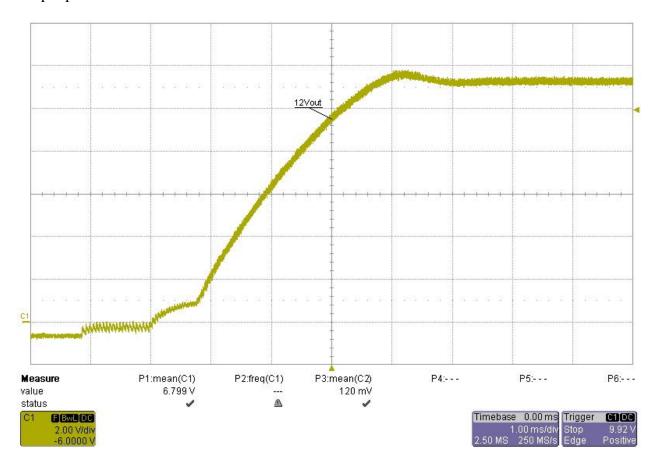
Input voltage = 230VAC Output power = 33W



PMP10020_RevB Test Results



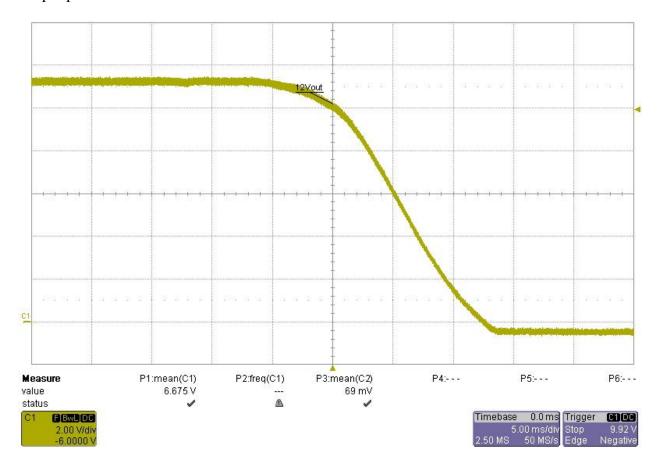
Input voltage = 90VACOutput power = 20W





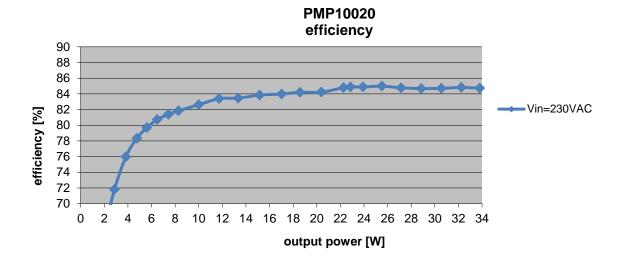
3 Shutdown (regulated 12V output)

Input voltage = 230VAC Output power = 33W

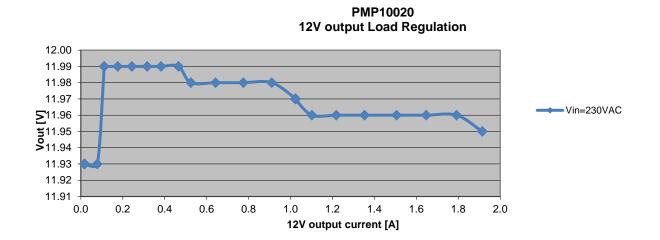




4 Efficiency

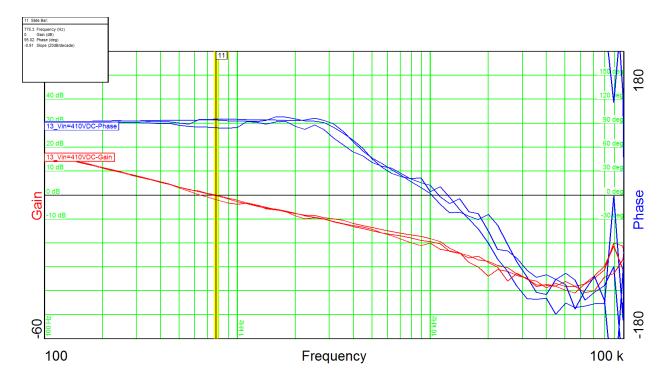


5 Load regulation (regulated 12V output)





6 Control Loop Frequency Response



 $\begin{array}{lll} \text{Output power} & = 24W \\ \text{Input voltage} & = 100VDC \\ \text{Phase margin} & = 94^{\circ} \\ \text{Bandwidth} & = 0.75\text{kHz} \end{array}$

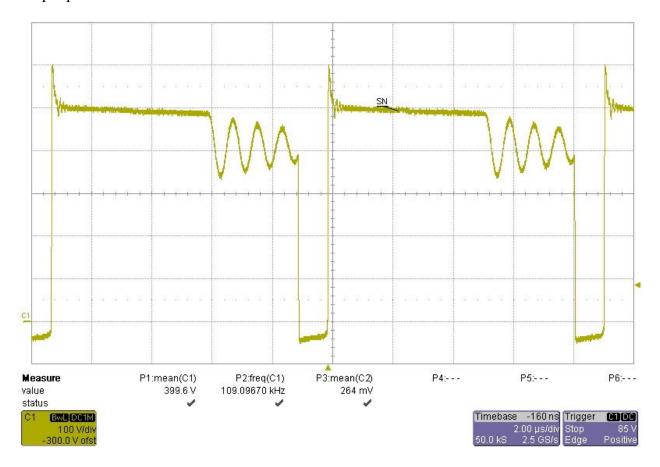
 $\begin{array}{ll} \text{Output power} & = 24W \\ \text{Input voltage} & = 325 \text{VDC} \\ \text{Phase margin} & = 95^{\circ} \\ \text{Bandwidth} & = 0.78 \text{kHz} \end{array}$

 $\begin{array}{lll} \text{Output power} & = 24W \\ \text{Input voltage} & = 410 \text{VDC} \\ \text{Phase margin} & = 85^{\circ} \\ \text{Bandwidth} & = 0.65 \text{kHz} \end{array}$



7 Switch Node

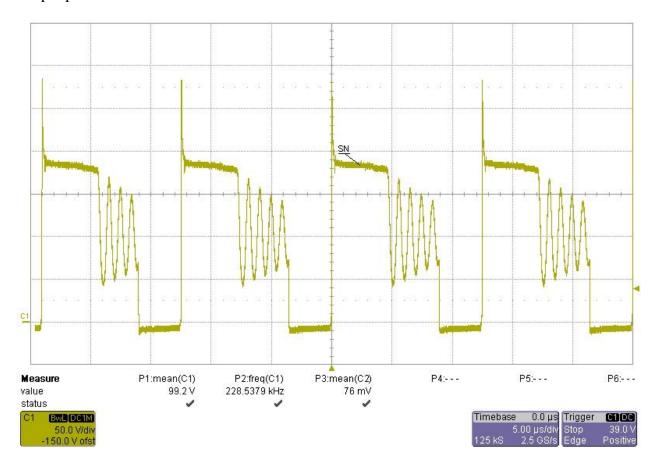
Input voltage = 410VDC Output power = 33W



PMP10020_RevB Test Results



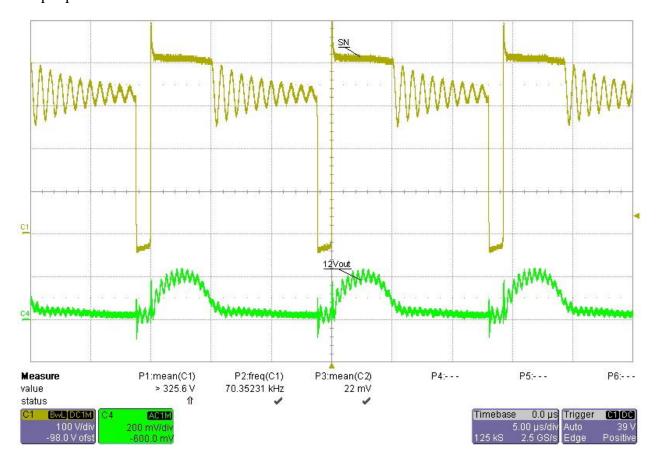
Input voltage = 100VDC Output power = 20W





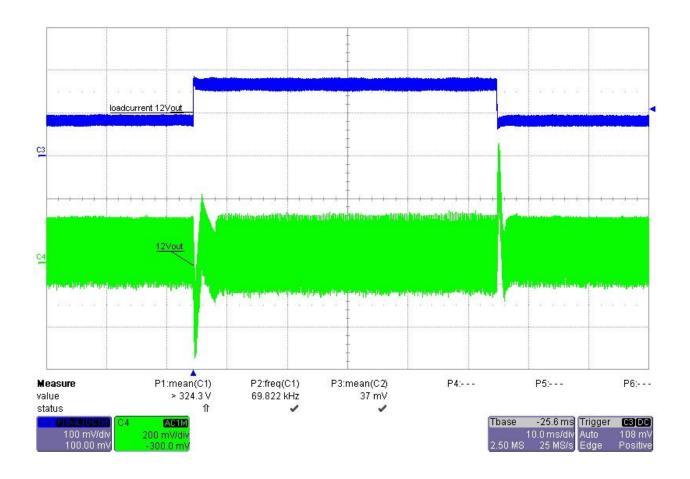
8 Output ripple voltage (regulated 12V output)

Input voltage = 325VDC Output power = 20W





9 Load Transients (regulated 12V output)



Input voltage = 325VDC Output power = 33W

Load current (12V output) = 0.9A to 1.9A

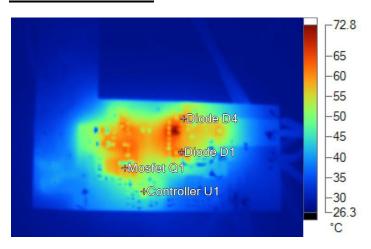


10 Thermal Analysis

The images below show the infrared images taken from the FlexCam after 15min at 20W output power.

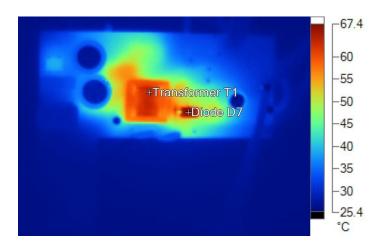
Input voltage = 230VAC Output power = 20W Ambient temperature = 25°C No heatsink, no airflow

Thermal Pic Bottom:



Name	Temperature	
Diode D4	61.4°C	
Diode D1	64.1°C	
Mosfet Q1	59.0°C	
Controller U1	54.3°C	

Thermal Pic Bottom:



Name	Temperature	
Transformer T1	63.8°C	
Diode D7	67.4°C	

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